

PRODUCT CHARACTERISTICS

V_{DS}	150V
$R_{DS(ON)}$ Typ(@ $V_{GS}=10V$)	3.9m Ω
Qg@typ	65nC
I_D	192A

APPLICATIONS

- * High efficiency switch mode power supplies
- * Electronic lamp ballasts based on half bridge
- * LED power supplies

FEATURE

- * High Switching Speed
- * Improved dv/dt capability

ORDER INFORMATION

Order Codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT7134E	TO-263	800 pieces/Reel

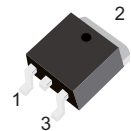
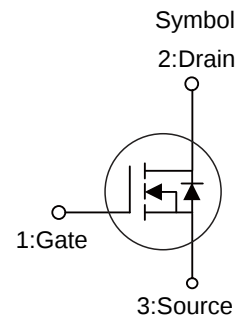
ABSOLUTE MAXIMUM RATINGS($T_A=25^{\circ}C$, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current Continuous(@ $V_{GS}=10V$, $T_A=25^{\circ}C$)	I_D	192	A
Drain Current Pulsed	I_{DM}	768	A
Avalanche Energy *	E_{AS}	1740	mJ
Power Dissipation	P_D	300	W
Junction Temperature	T_J	+175	$^{\circ}C$
Storage Temperature	T_{STG}	-55~ +175	$^{\circ}C$

THERMAL CHARACTERISTICS

Parameter	Symbol	Typ	Unit
Junction to Case	R_{thJC}	0.5	$^{\circ}C/W$

Note: * EAS condition: $T_J=25^{\circ}C$, $V_{DD}=30V$, $V_G=10V$, $L=0.5mH$, $R_g=25\Omega$



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■ ELECTRICAL CHARACTERISTICS ($T_C=25^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Off characteristics						
Drain to Source Breakdown Voltage	V _{DSS}	V _{GS} =0V,I _D =250μA	150	-	-	V
Drain to Source Leakage Current	I _{DSS}	V _{DS} =150V,V _{GS} =0V	-	-	1	μA
Gate to Source Forward Leakage	I _{GSS(F)}	V _{DS} =0V, V _{GS} =+20V	-	-	100	nA
Gate to Source Reverse Leakage	I _{GSS(R)}	V _{DS} =0V, V _{GS} =-20V	-	-	-100	nA
On characteristics						
Drain to Source On-Resistance	R _{DS(ON)}	V _{GS} =10V,I _D =20A	-	3.9	4.8	mΩ
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} ,I _D =250μA	2	3.1	4	V
Dynamic characteristics						
Gate Resistance	R _g	V _{GS} =0V,V _{DS} =0V ,f=1.0MHz	-	1	-	Ω
Forward Transconductance	g _{fs}	V _{DS} =10V,I _D =5A	-	21	-	S
Input Capacitance	C _{iss}	V _{DS} =75V,V _{GS} =0V f=1.0MHz	-	5100	-	pF
Output Capacitance	C _{oss}		-	1300	-	pF
Reverse Transfer Capacitance	C _{rss}		-	38	-	pF
Resistive Switching Characteristics						
Turn-on Delay Time	t _{d(ON)}	I _D =20A, V _{DS} =75V R _G =3Ω ,V _{GS} =10V	-	88	-	ns
Rise Time	t _r		-	57	-	ns
Turn-off Delay Time	t _{d(OFF)}		-	32	-	ns
Fall Time	t _f		-	16	-	ns
Total Gate Charge	Q _g	I _D =20A, V _{DS} =75V V _{GS} =10V	-	65	-	nC
Gate to Source Charge	Q _{gs}		-	25	-	nC
Gate to Drain("Miller") Charge	Q _{gd}		-	11	-	nC
Source-Drain Diode Characteristics						
Continuous Source Current(Body Diode)	I _S		-	-	192	A
Maximum Pulsed Current(Body Diode)	I _{SM}		-	-	768	A
Diode Forward Voltage	V _{SD}	I _{SD} =1A, V _{GS} =0V	-	0.67	1.2	V
Reverse Recovery Time	t _{rr}	I _{SD} =20A, T _J =25 °C dI/dt=100A/μs	-	117	-	ns
Reverse Recovery Charge	Q _{rr}		-	476	-	nC

TYPICAL CHARACTERISTICS

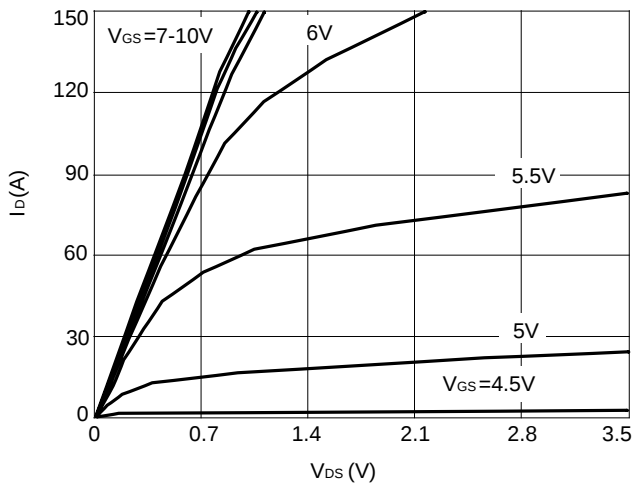


Figure 1: Output Characteristics

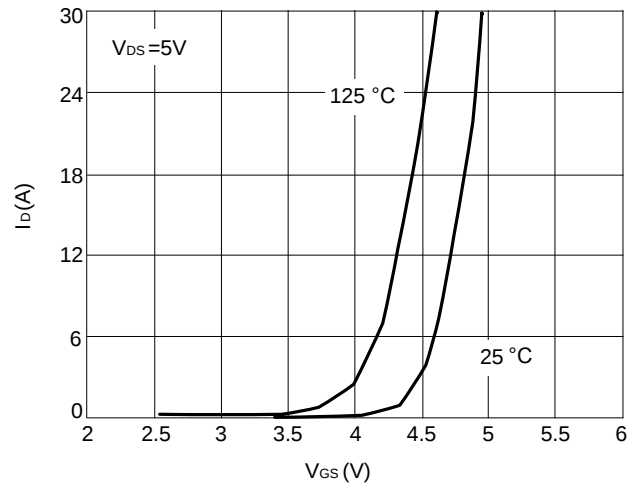


Figure 2: Transfer Characteristics

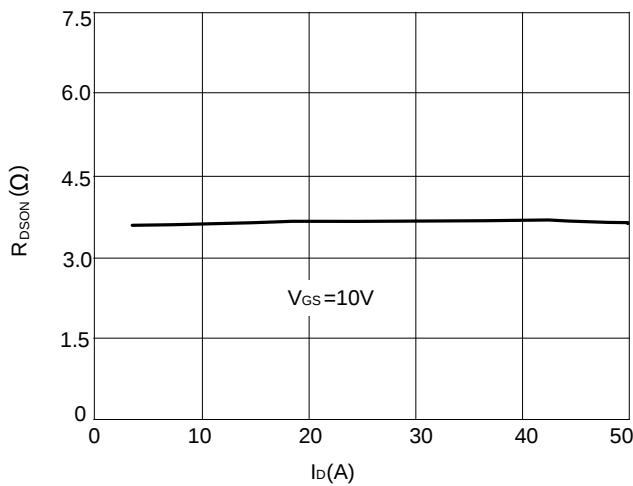


Figure 3: $R_{DS(ON)}$ vs. Drain Current

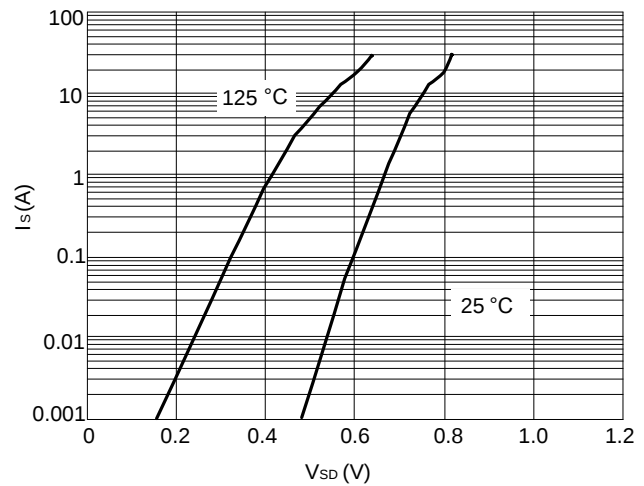


Figure 4: Body Diode Characteristics

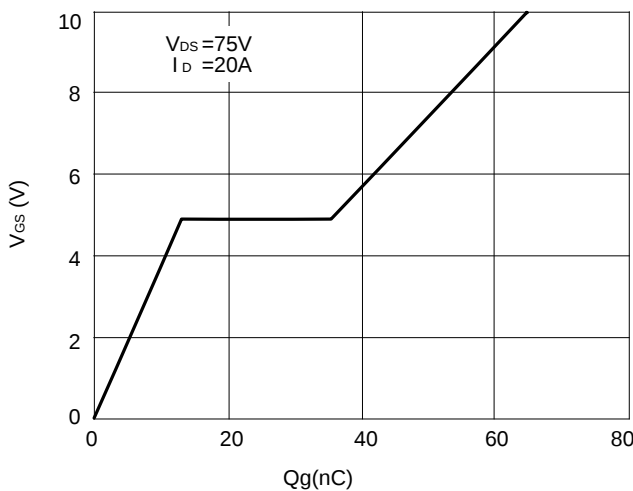


Figure 5: Gate Charge Characteristics

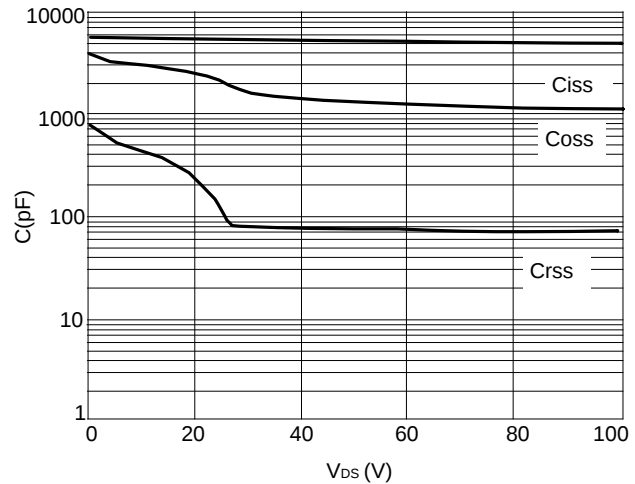


Figure 6: Capacitance Characteristics

■ TYPICAL CHARACTERISTICS(Cont.)

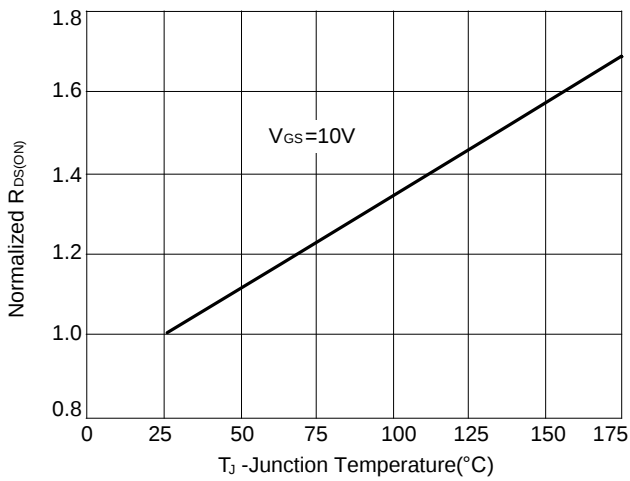


Figure 7: Normalized on Resistance vs. Junction Temperature

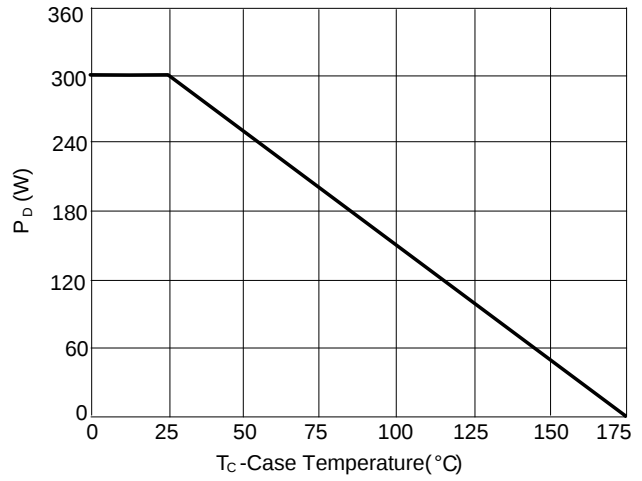


Figure 8: Power De-rating

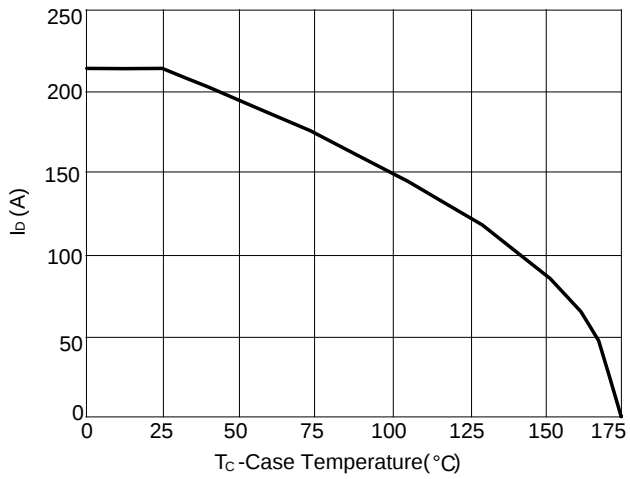


Figure 9: Current De-rating

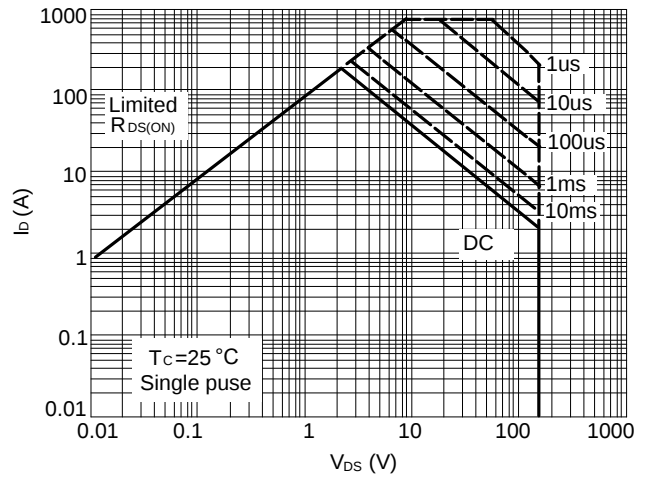


Figure 10: Maximum Safe Operating Area

■ TO-263 PACKAGE OUTLINE DIMENSIONS

